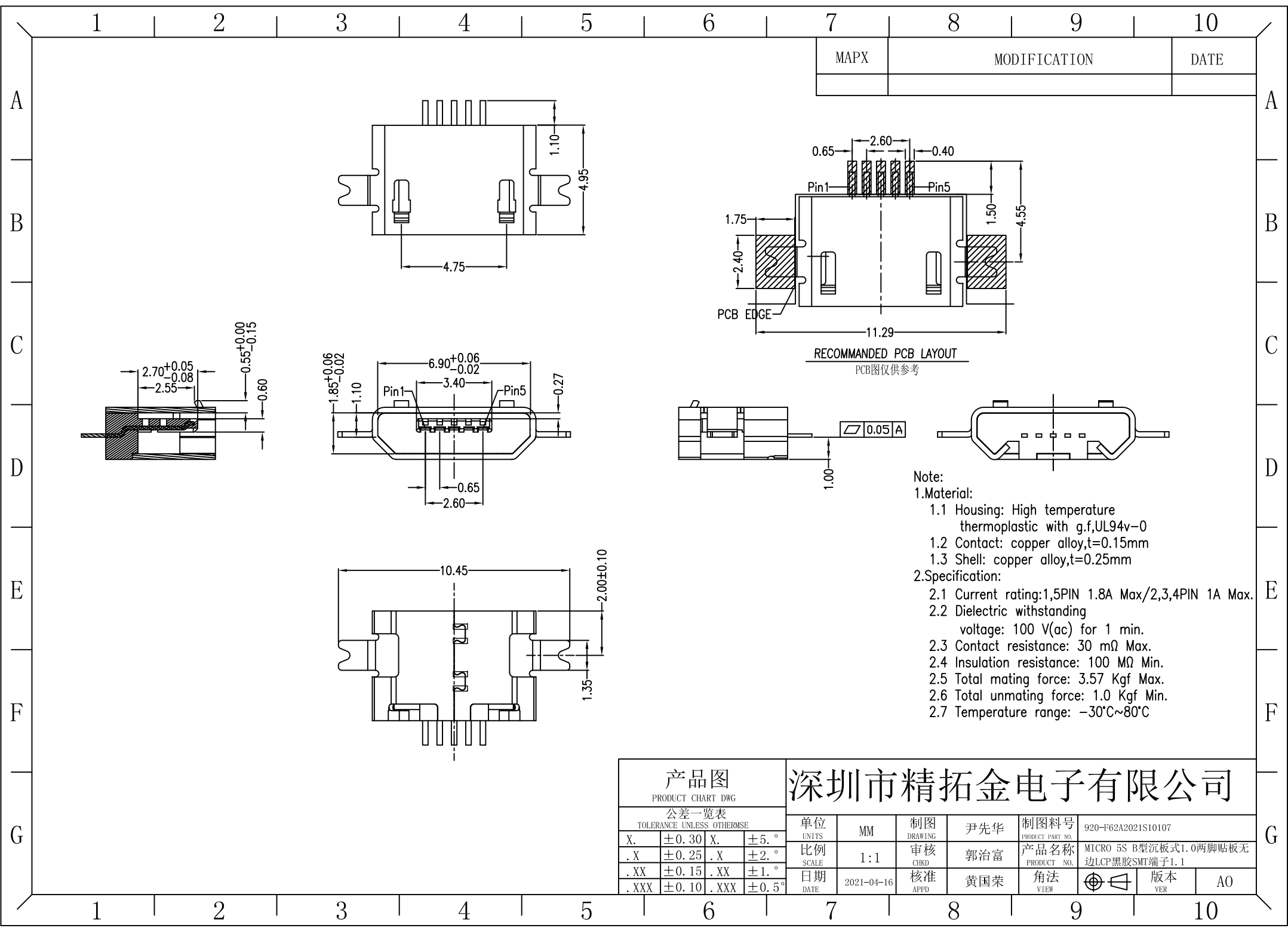




MAPX	MODIFICATION	DATE

RECOMMENDED PCB LAYOUT
PCB图仅供参考

- Note:
- 1.Material:
- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
 - 1.2 Contact: copper alloy,t=0.15mm
 - 1.3 Shell: copper alloy,t=0.25mm
- 2.Specification:
- 2.1 Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
 - 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - 2.3 Contact resistance: 30 mΩ Max.
 - 2.4 Insulation resistance: 100 MΩ Min.
 - 2.5 Total mating force: 3.57 Kgf Max.
 - 2.6 Total unmating force: 1.0 Kgf Min.
 - 2.7 Temperature range: -30°C~80°C

产品图 PRODUCT CHART DWG				深圳市精拓金电子有限公司					
公差一览表 TOLERANCE UNLESS OTHERWISE				单位 UNITS	MM	制图 DRAWING	尹先华	制图料号 PRODUCT PART NO.	920-F62A2021S10107
X.	±0.30	X.	±5.°	比例 SCALE	1:1	审核 CHKD	郭治富	产品名称 PRODUCT NO.	MICRO 5S B型沉板式1.0两脚贴板无边LCP黑胶SMT端子1.1
.XX	±0.15	.XX	±1.°	日期 DATE	2021-04-16	核准 APPD	黄国荣	角法 VIEW	
.XXX	±0.10	.XXX	±0.5°					版本 VER	AO